



Product Change Notification

Change Notification #: 116580 - 00
Change Title: Intel® RAID Module RMSP3AD160F
Intel® RAID Module RMSP3CD080F
Intel® RAID Module RMSP3HD080E,
PCN 116580-00, Product Design, Label,
Add KCC Logo and Firmware Update
Date of Publication: November 05, 2018

Key Characteristics of the Change:

Product Design, Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	November 20, 2018
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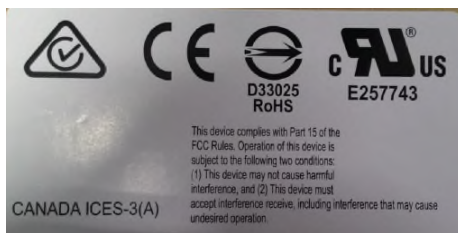
**Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

Description of Change to the Customer:

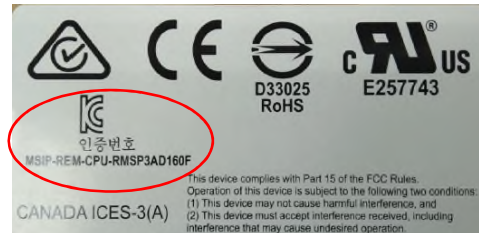
Intel is implementing the following changes on the Intel® RAID Modules, RMSP3AD160F, RMSP3CD080F and RMSP3HD080E:

1. Update the firmware version to 5.020.00-0838 (MR 7.2p1 on firmware package 50.2.1-0589)
2. Add the KCC logo for Korea certification

Before



After



Customer Impact of Change and Recommended Action:

Intel does not expect any other impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason Intel recommends that the customer perform a standard level of evaluation. Customers can download and evaluate the latest BIOS/ME/Integrated BMC and FRUSDR release notes for more information at <http://www.intel.com/support>.

Contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
RMSP3CD080F	954489	J24903-003	J24905-201	J24903-004	J24905-202
RMSP3AD160F	954552	J25668-003	J25669-201	J25668-004	J25669-202
RMSP3HD080E	954553	J32824-003	J32825-201	J32824-004	J32825-202

PCN Revision History:

Date of Revision:

November 5, 2018

Revision Number:

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Reason:

Originally Published PCN



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116580 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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